

Title (en)
MODULE MOUNTING ASSEMBLY.

Title (de)
MODULZUSAMMENBAUEINHEIT.

Title (fr)
ASSEMBLAGE DE MONTAGE DE MODULE.

Publication
EP 0124593 A4 19870129 (EN)

Application
EP 83903743 A 19831101

Priority
US 43938982 A 19821105

Abstract (en)
[origin: WO8401859A1] Apparatus for mounting an integrated circuit module (2) on a printed wiring circuit board (3). The apparatus assembly (1) comprises a ring member (13) for use in assembling a generally rectangular insulating member (11) having a plurality of electrical conducting members (10) positioned therein with a plurality of other insulating members (12) to form quadrilateral configurations of first and second contacts (101, 102) for contacting module terminals (20) and the printed wiring circuit board. A one piece cover (14) engages the ring member to spring clamp the module on the rectangular insulating member and maintain each module terminal in engagement with a corresponding first contact to electrically couple the module with the printed wiring circuit board.

IPC 1-7
H01R 23/72

IPC 8 full level
H05K 7/10 (2006.01)

CPC (source: EP)
H05K 7/1069 (2013.01)

Citation (search report)
[E] EP 0146242 A2 19850626 - AMP INC [US]

Designated contracting state (EPC)
DE FR GB

DOCDB simple family (publication)
WO 8401859 A1 19840510; EP 0124593 A1 19841114; EP 0124593 A4 19870129

DOCDB simple family (application)
US 8301692 W 19831101; EP 83903743 A 19831101